

PCN # 1568

DATE: September 4, 2015

EXPECTED PCN SHIP DATE: February 8, 2019



Quality Assurance  
160 Rio Robles  
San Jose, CA 95134

www.maximintegrated.com

**PROCESS CHANGE NOTICE**  
 **PRODUCT CHANGE NOTICE**

**MAXIM INTEGRATED** HEREBY ISSUES NOTIFICATION OF CHANGE  
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN     WAFER FAB     ASSEMBLY     TEST     ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: Current assemblers use the 1.0 mil gold bond wires

CHANGE TO: Current assemblers to use 1.0 mil Pd coated Copper bond wires

JUSTIFICATION: Maxim is expanding the assembly capacity at UTAC Thai Limited (UTL) and ASE Chung-Li (ASE CL)L6 by qualifying the MAX2659 on UTL and ASE-CL's high volume copper bond wire line. There are no changes to the form, fit, or function of the devices.

Please see the attached reliability reports for each assembler.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

*Nasser Ali Chaouche*

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

**Contact your local Maxim Integrated Company Representative**    or    Nasser AliChaouche, PCN Coordinator  
408-601-5660 / pcn.coordinator@maximintegrated.com